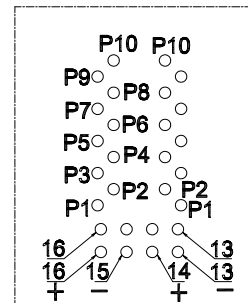
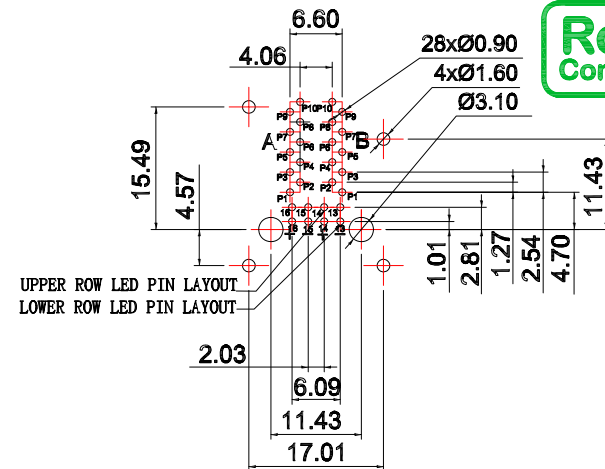


MJ45-T826GYGY-x-S118

鍍層厚度:

Blank : 1u"
1 : 3u"
2 : 15u"
3 : 30u"
5 : 6u"
6 : 50u"

DETAIL A
SCALE 3:2

P.C.B LAYOUT

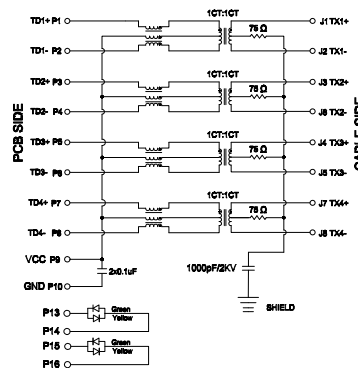
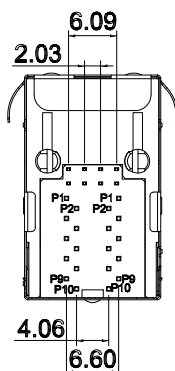
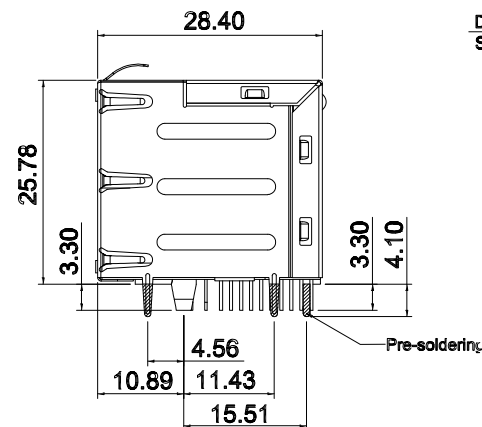
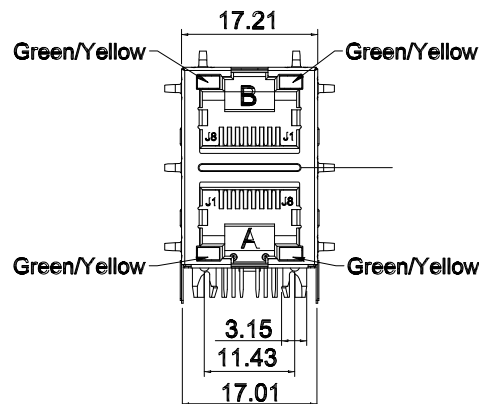
PARAMETER	SPECIFICATIONS
URNS RATIO	1:1±2%
INDUCTANCE(OCL)	350uH MIN@100KHz/100mV With 8mA DC Bias
INSERTION LOSS	-1.0dB MAX@0.3MHz-100MHz;
RETURN LOSS (Z out=100 OHM)	-18dB MIN@1MHz-30MHz; -18dB MIN@30MHz-80MHz; -12dB MIN@80MHz-80MHz; -10dB MIN@80MHz-100MHz;
CROSSTALK (ADJACENT CHANNELS)	-30dB MIN@1-100MHz;
COMMON MODE REJECTION RATIO	-30dB MIN@1-100MHz;
HI-POT	2250 VDC@60 SECONDS

LED SPECIFICATION			
STANDARD LED	WAVELENGTH	Forward V(fwd)	TYP
GREEN/YELLOW	570/590nm	2.8V/3.2V	2.1/2.2V

*WITH A FORWARD CURRENT OF 20mA

MATERIALS

1.HOUSING: PA46(BLACK)
2.CONTACT: PHOSPHOR BRONZE OVERALL DUCTILE NICKEL UNDERPLATE WITH SELECTED 6 MICROINCHES GOLD AT MATING INTERFACE
3.SHIELD: STAINLESS.
4.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 SUBPART F
5.THE PART IS RECOMMENDED FOR WAVE SOLDERING PROCESS PEAK SOLDERING TEMPERATURE IS 260°C MAX,10 SECS MAX.
6.OPERATING TEMPERATURE:-40°C TO +85°C. STORAGE TEMPERATURE:-40°C TO +85°C.



Schematic

CONTACT

建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.TOLERANCE UNLESS
OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°3RD.
ANGEL'S

UNITS

MM

DRAWN BY:	DATE	MAT'L	TITLE	RJ45
Jack Lu	07/05/21	FINISH	MODLE	RJ45 2x1 Through Hole 10 100 1000 BASE-T WITH LED
CHECKED BY:	DATE	SCALE	DWG NO.	MJ45-T826GYGY-x-S118
Jacky Chen	07/05/21	1 : 1	PART NO.	MJ45-T826GYGY-x-S118
APPROVED BY:	DATE	SHEET NO.	2 of 1	SIZE A4 VER R
Tony Kao	07/05/21			